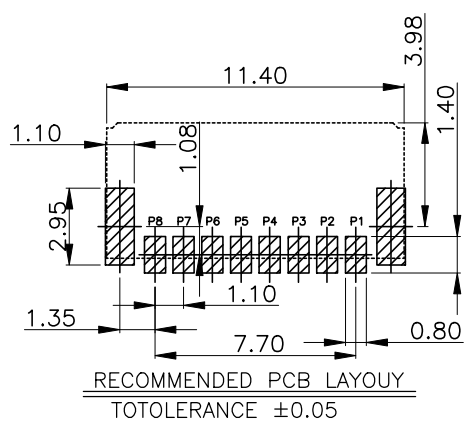
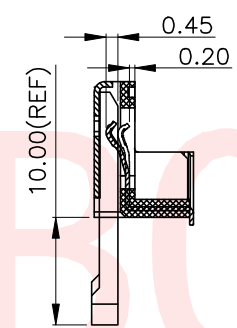
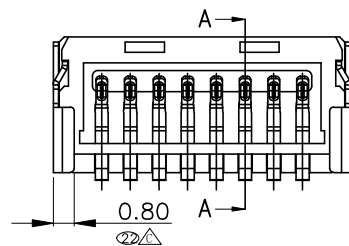
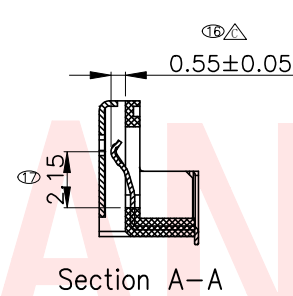
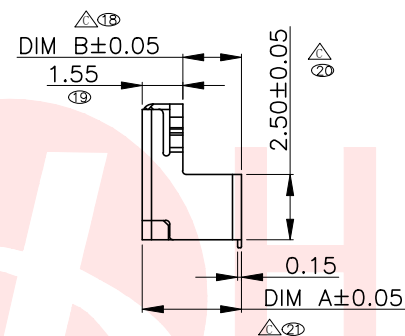
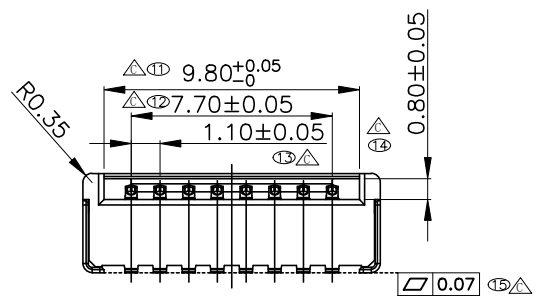
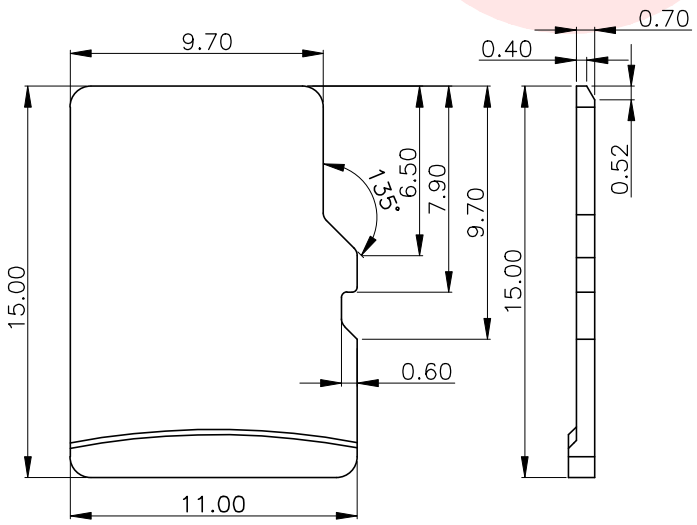
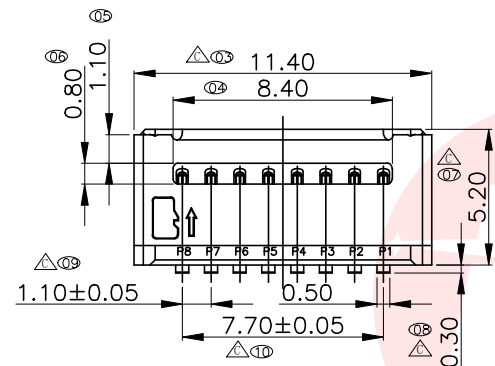
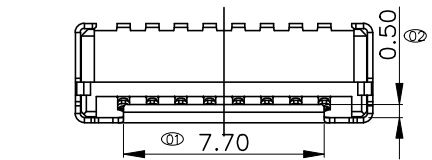
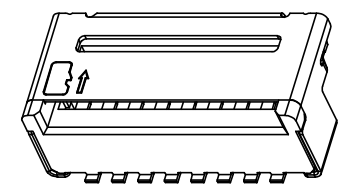




REV.	ECN NO OR DESCRIPTION	REVISED	DATE



- 注解:
1. 素材要求:
 - 1.1 胶芯: LCP 30%GF, 防火等级: UL94V-0. 颜色: 黑色;
 - 1.2 端子: C5191-H, T=0.15MM
 - 1.3 外壳: SUS201 1/2H, T=0.20MM
 2. 电镀要求:
 - 2.1 端子: 接触区镀金1U", 焊脚区域镀雾锡100~120U", 全部区域电镀镍底50U".
 3. 电气性能要求:
 - 3.1 额定电流 1.0A, 额定电压 30V
 - 3.2 耐压交流电压最小100VAC.
 - 3.3 绝缘电阻最小100M 欧姆.
 - 3.4 接触电阻最大50毫欧.
 4. 环境性能要求:
 - 4.1 使用环境-30摄氏度~80摄氏度
 - 4.2 部件耐热焊接温度符合230摄氏度30~60秒, 260摄氏度10秒要求.
 5. "△" 为QC重点量测尺寸
 6. "⊗" 为FAI量测尺寸
 7. 部件符合RHOS 2005/95/EC.

PIN NO.	NAME
P1	DAT 2
P2	CD/DAT
P3	CMD
P4	VDD
P5	CLK
P6	VSS
P7	DAT0
P8	DAT1

TABLE A:

规格	DIM A	DIM B	料号
H3.80	3.80	2.25	TF-109H38
H3.25	3.25	1.70	TF-109H325
H5.0	5.0	3.45	TF-109H50
H2.55	2.55	1.0	TF-109H255
H3.0	3.0	1.45	TF-109H30
H1.7	1.7	0.15	TF-109H17
H4.5	4.5	2.95	TF-109H45

UNLESS OTHERWISE SPECIFIED TOLERANCES

DECIMALS: ANGLES:
X :±0.30 X :±2°
X.X :±0.20 X.X :±1°
X.XX :±0.10

东莞市汉博电子科技有限公司
DONGGUAN HANBO TECHNOLOGY CO., LTD

TITLE	MICRO SD 避空短体TF卡座1.7/5.0H			
DWN	xiong	PART NO.	TF-109HXXX	
CHKD	lee	SCALE:1:1	UNIT: mm	REV: A4
APVD	wang	SIZE: A4	SHEET:10F 1	REV: A4
CUSTOMER COPY				